DIGI-KEY CORPORATION

Issue No.	:	151RJ000	07363
Date of Issue	:	June 01.2	007
Classification	:	■ New	□ Changed

PRODUCT SPECIFICATION FOR APPROVAL

Product Description	:	Thick Film Chip Resistors (RoHS)
Product Part Number	:	ERJXGNJ * * * Y

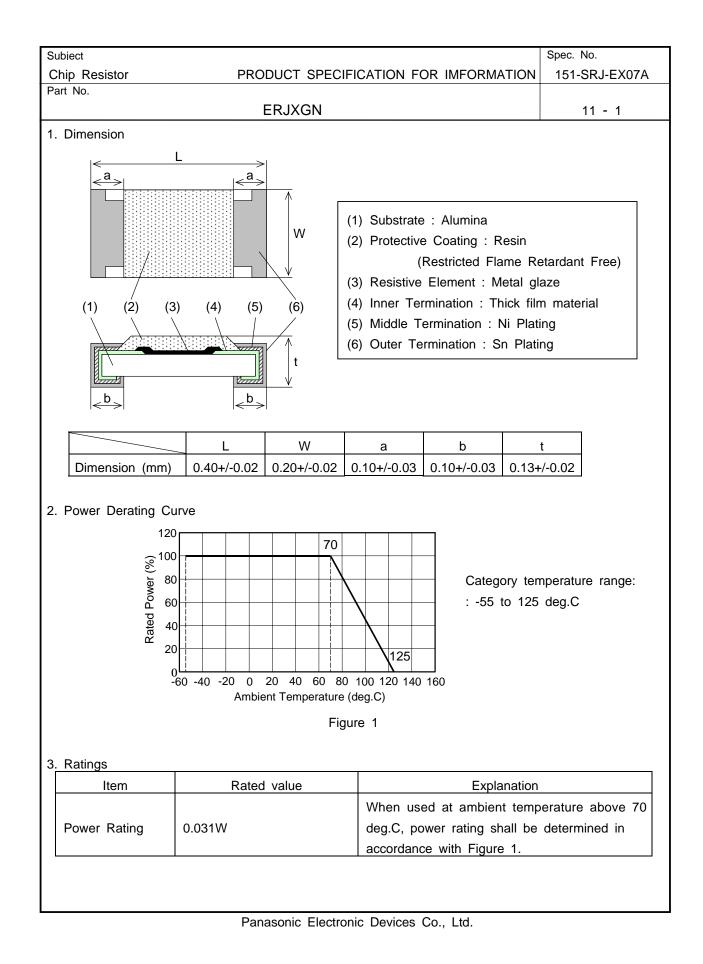
Country of Origin: JAPANApplications: Standard electronic equipment

*If you approve this specification, please fill in and sign the below and return 1 copy to us.

	Approval No	:			
	Approval Date	:			
2					/
	Executed by	:			
			(signature)	· · · · · ·	
	Title				
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	Dept.	:			
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Chip Resistor	PRODUCT SPECIFI	CATION FOR IMFORMATION	Spec. No. 151-SRJ-EX07/	
Part No.	ERJXGN		11 - 2	
	[r		
Item	Rated value	Explanation	1	
	The rated voltage of each re	esistance should be calculated	from the equatio	
Rated voltage &	below. And when the rated w	voltage exceeds the maximum	RCWV,	
Rated Continuous	the maximum RCWV should	be the rated voltage.		
Working Voltage	Rated voltage = (Power rati	Rated voltage = (Power rating x Resistance Value) ^{1/2}		
	The maximum RCWV : 15V			
	The overload voltage should	be 2.5 times the rated voltage	e. And when	
Max.	the voltage exceeds the max	imum overload voltage, the va	alue shown below	
Overload Voltage	should be the maximum over	rload voltage.		
	The maximum overload volta	age : 30V		
Resistance				
Tolerance	J : +/- 5%			
. Explanation of Par	J X G N [<u>J</u> <u>1</u> <u>0</u> <u>2</u> <u>Y</u> (3) (4) (5)]	
L Explanation of Par <u>E R</u> (1) (1) Product Code :	t Number J X G N (2) Thick Film Chip Resistor I Power : 0.4 mm x 0.2 mm, (J <u>1 0 2 Y</u> (3) (4) (5) 0.031 W]	
E E R (1) (1) (2) Size and Rated	t Number J X G N (2) Thick Film Chip Resistor Power : 0.4 mm x 0.2 mm, 0 Restricted Flame Ret	J <u>1 0 2 Y</u> (3) (4) (5) 0.031 W]	
I. Explanation of Par [E] R [(1) (1) Product Code : (2) Size and Ratec (3) <u>Resistance Tole</u>	t Number J X G N (2) Thick Film Chip Resistor Power : 0.4 mm x 0.2 mm, 0 Restricted Flame Ret	J <u>1 0 2 Y</u> (3) (4) (5) 0.031 W]	
E Explanation of Par E R (1) (1) Product Code : (2) Size and Ratec (3) Resistance Tole	t Number J X G N (2) Thick Film Chip Resistor Power : 0.4 mm x 0.2 mm, 0 Restricted Flame Ref	J <u>1 0 2 Y</u> (3) (4) (5) 0.031 W]	
E E R (1) (1) Product Code : (2) Size and Ratec (3) Resistance Tole	t Number J X G N (2) Thick Film Chip Resistor I Power : 0.4 mm x 0.2 mm, 0 Restricted Flame Ref erance Resistance Tolerance +/- 5%	J <u>1 0 2 Y</u> (3) (4) (5) 0.031 W]	
Explanation of Par E R (1) (1) Product Code : (2) Size and Ratec (3) Resistance Tole Code F J (4) Resistance Value	t Number J X G N (2) Thick Film Chip Resistor I Power : 0.4 mm x 0.2 mm, 0 Restricted Flame Reserved Resistance Tolerance +/- 5%	J <u>1</u> 0 <u>2</u> <u>Y</u> (3) (4) (5) 0.031 W tardant Free] last figure shows	
 Explanation of Par E R (1) (1) Product Code : (2) Size and Rated (3) Resistance Tole Code F J (4) Resistance Value The first two 	t Number J X G N (2) Thick Film Chip Resistor I Power : 0.4 mm x 0.2 mm, 0 Restricted Flame Ref erance Resistance Tolerance +/- 5%	J <u>1</u> 0 <u>2</u> <u>Y</u> (3) (4) (5) 0.031 W tardant Free] last figure shows	
 4. Explanation of Par E R (1) (1) Product Code : (2) Size and Rated (3) Resistance Tole Code F J (4) Resistance Value The first two the number of 	t Number J X G N (2) Thick Film Chip Resistor I Power : 0.4 mm x 0.2 mm, 0 Restricted Flame Ref erance Resistance Tolerance +/- 5% ue digits are the significant figures f zero following in ohm.	J <u>1</u> 0 <u>2</u> <u>Y</u> (3) (4) (5) 0.031 W tardant Free] last figure shows	
 4. Explanation of Par E R (1) (1) Product Code : (2) Size and Rated (3) Resistance Tole (3) Resistance Value (4) Resistance Value (4) Resistance Value (5) Packaging Control 	t Number J X G N (2) Thick Film Chip Resistor I Power : 0.4 mm x 0.2 mm, 0 Restricted Flame Ref erance Resistance Tolerance +/- 5% ue digits are the significant figures f zero following in ohm.	J <u>1</u> 0 <u>2</u> <u>Y</u> (3) (4) (5) 0.031 W tardant Free] last figure shows	

Subject			Spec. No.
Chip Resistor Part No.	PRODUCT SPECIFI	CATION FOR IMFORMATION	151-SRJ-EX07A
art no.	ERJXGN		11 - 3
5. Appearance & C	onstruction		
Item	Specification	Explanation	
Appearance & Construction	 fade easily. The surface of and discoloration. 2. The electrode should be properties the plating should not fad pinhole, projection and disting the electrode should be created by the element. 	connected electrically, mechanic te should be as in the list and	ness, flaw, pinhole the dimensions. evenness, flaw, cally to resistive
	nave chipping, flaw, flash and	сгаск.	

 Subject
 Spec. No.

 Chip Resistor
 PRODUCT SPECIFICATION FOR IMFORMATION
 151-SRJ-EX07A

 Part No.
 ERJXGN
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 As far as there shall not designation especially, the following tests and measurement shall be operated under the following conditions.

 Normal temperature
 : 5 deg.C to 35 deg.C

Normal humidity : 45 % to 85 %

Normal atmospheric pressure : 86 k Pa to 106 k Pa

6. Performance Specification

Item	Specification	Test Method (JIS-C5201-1)
DC resistance	DC resistance value shall be within the specified tolerance.	At 20 deg.C, 65%RH
Temperature coefficient of resistance (TCR)	10 ohm – 91 ohm : +/- 300 x 10 ⁻⁶ /deg.C 100 ohm – 1 M ohm : +/- 200 x 10 ⁻⁶ /deg.C	Natural resistance change per temperature degree centigrade. $TCR=(R_2-R_1)x10^6/R_1(t_2-t_1)$ (x10 ⁻⁶ /deg.C) R_1 : Resistance value at reference temperature (t ₁) R_2 : Resistance value at test temperature (t ₂) t_1 : 25 deg.C, t_2 : 125 deg.C
Short time overload	ΔR : +/-(2%+0.1 ohm)	Resistors shall be applied 2.5 times the rate voltage for 5 seconds. Max. overload voltage shall be 30V.
Intermittent overload	∆R : +/-(5%+0.1 ohm)	Resistors shall be subjected to 10000 cycles of 2.5 times the rated voltage applied for 1 second with pause of 25 seconds between tests. Max. overload voltage shall be 30V.

hip Resistor	PRODUCT SPECIFI	CATION FOR IMFORMATION	151-SRJ-EX07A
art No.	ERJXGN		11 - 5
Machinery charac	cteristic	1	
Item	Specification	Test Method (JIS-C	5201-1)
Bending	No mechanical damage.	Substrate : Glass epoxy (t=1 Span : 90mm Bending distance : 3mm (10 <test pattern=""> 0.2 0.2 0.2 0.2</test>	
strength	∆R : +/-(1%+0.05 ohm)		
Solderability	Termination should be covered uniformly with solder (Min. 95% coverage)	Resistors shall be dipped in bath at 235 deg.C +/- 5 deg +/- 0.5 second. Flux shall be the surface of termination wit solvent.	J.C for 2 seconds removed from
Resistance to soldering heat	∆R : +/-(1%+0.05 ohm)	Resistors shall be dipped in bath at 270 deg.C +/- 3 deg +/- 1 second.	
Resistance to vibration (Low frequency)	∆R : +/-(1%+0.05 ohm)	Resistors shall be subjected vibration having as double a mm in 3 directions perpendi for 2 hours each. (6 hours ir The vibration frequency shall uniformly from 10 Hz to 55 H to 10 Hz traversing for 1 mir	mplitude of 1.5 cular one another n total) I be varied Hz, and return
Resistance to	Without distinct deformation in appearance	Solvent solution : Isopropyl a (1)Dipping 10 +/- 1 hours, dr condition for 30 +/- 10 min	lcohol y in room
solvent	∆R : +/-(0.5% +0.05 ohm)	(2)Ultrasonic wave washing : (0.3W/cm ² ,28 Dry in room condition for	kHz)

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Subject

Chip Resistor Part No.

PRODUCT SPECIFICATION FOR IMFORMATION

Spec. No. 151-SRJ-EX07A

ERJXGN

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8. Environmental test

Item	Specification	Test Method (JIS-C5201-1)
Low temperature exposure	∆R : +/-(1%+0.05 ohm)	Resistors shall be exposed at -55 deg.C +/- deg.C with no load for 1000 hours +48/-0 hours.
High temperature exposure	∆R : +/-(1%+0.05 ohm)	Resistors shall be exposed at 125 deg.C +/- deg.C with no load for 1000 hours +48/-0 hours.
Temperature cycling	∆R : +/-(1%+0.05 ohm)	Resistors shall be tested for 5 cyclescontinuously in accordance with the followingduty cycle.StepTemperature (deg.C)Time (min.)1-55 +/-3302Room temperatureMax. 33+125 +/-3304Room temperatureMax.3
Humidity (Steady state)	∆R : +/-(1%+0.05 ohm)	Resistors shall be exposed at 60 deg.C +/- 2 deg.C and 90% to 95% relative hummidity in a humidity test chamber for 1000 hours +48/- hours.
Load life	∆R : +/-(3%+0.1 ohm)	Resistors shall be operated at DC rated voltage (1.5 hours "ON", 0.5 hours "OFF") for 1000 hours +48/-0 hours in a test chamber controlled at 70 deg.C +/-2 deg.C.
Load life in humidity	∆R : +/-(3%+0.1 ohm)	Resistors shall be operated at DC rated voltage (1.5 hours "ON", 0.5 hours "OFF") for 1000 hours +48/-0 hours in a test chamber controlled at 60 deg.C +/- 2 deg.C and at 90 % to 95% in relative hummidity.

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Chip Resistor Part No.	PRODUCT SPECIFICATION FOR IMFORMAT	TON 151-SRJ-EX07A
	ERJXGN	11 - 7
 Common precaution 	ns in handling resistors	
	<u>Notice for use</u>	
(1) This specification	ion shows the quality and performance of a unit compo	onent. Before adoption,
be sure to ev	aluate and verify the product mounting it in your produc	ct.
(2) We take no re this specificati	esponsibility for troubles caused by the product usage the	nat is not specified in
	lesign and ensure safety by carrying out the following it	tems in cases where it
	at the failure of the product gives serious damage to so	
human life, fo	r instant in traffic transportation equipment (trains, cars,	traffic signal
equipment, etc	c.), medical equipment, aerospace equipment, electric h	eating appliances,
combustion ar	nd gas equipment, rotating equipment, disaster and crim	ne preventive
equipment.		
*Ensure safety	y as the system by setting protective circuits and protective	ctive equipment.
*Ensure safety	y as the system by setting such redundant circuits as o	to not cause danger by
a single failu	re.	
(4) When a dogma	a shall be occurred about safety for this product, be su	ure to inform us rapidly,
operate your t	technical examination.	
(5) The product is	designed to use in general standard applications of ge	eneral electric
equipment (A)	V products, household electric appliances, office equipm	ent, information and
communication	n equipment, etc.); hence, it do not take the use under	the following special
	into consideration.	
	he use in the following special environments, and such	
	y affect the performance of the product; prior to use, v	erify the performance,
reliability, etc.		
	ids such as water, oil, chemical, and organic solvent.	
	direct sunlight, in outdoor or in dusty atmospheres.	
	ces full of corrosive gases such as sea breeze, Cl_2 , H_2	
	vironment with large static electricity or strong electroma	-
	product is close to a heating component, and where a chloride wire is arranged close to the product.	n inflammable such as
6) Where the	resistor is sealed or coated with resin, etc.	
	er or a water-soluble detergent is used in cleaning free fter soldering (Pay particular attention to soluble flux.)	soldering and in flux
-	h a place where the product is wetted due to dew con	densation.
(6) If transient loa	d (heavy load in a short time) like pulse is expected to	be applied, carry out
evaluation and	d confirmation test with resistors actually mounted on yo	our own board. When
1	ore than rated power is applied under the load condition	

Subject		Spec. No.
Chip Resistor	PRODUCT SPECIFICATION FOR IMFORMATION	151-SRJ-EX07A
Part No.	ERJXGN	11 - 8
may impair	performance and/or reliability of resistor. Never exceed the rate	ed power. When
	shall be used under special condition, be sure to ask us in a	•
(7) Halogen type	e (Chlorine type, Bromine type, etc.) or other high-activity flux	is not
recommende	ed as the residue may affect performance or reliability of resist	tors.
(8) When solderi	ing with soldering iron, ground a tip of the soldering iron neve	er touch the body
of the chip i	resistor with a tip of the soldering iron. When using a solderin	ng iron with a tip
at high temp 350 deg.C)	perature, solder for a time as short as possible. (three second	s or less up to
(9) Avoid physica	al shock to the resistor and nipping of the resistor with hard t	tool (a pair of
pliers or twe resistor's pe	eezers) as it may damage protective film or the body of resister	or and may affect
	rsion of chip resistor in solvent for long time. Use solvent after	er the effect of
immersion	is confirmed.	
(11) This resista	nce may change with ESD.	
In case of	handling this product, please take care as follows.	
Enviro	onment which static electricity cannot generate easily.	
(Re	commendation humidity: 40 - 60%)	
Weari	ng of an earth band and a conductive glove.	
Conne	ecting surface mounting system to the earth.	
Install	ation of the electric conduction mat on a work table.	
solderability may (1) Storage in pla (2) Storage in pla (3) Storage in pla range of 45 (4) Storage over	stored in the following environments and conditions, the perfo be badly affected, avoid the storage in the following environm aces full of corrosive gases such as sea breeze, Cl ₂ , H ₂ S, NH aces exposed to direct sunlight. aces outside the temperature range of 5 deg.C to 35 deg.C a %RH to 85 %RH. a year after our delivery (This item also applies to the case bified in item (1) to (3) has been followed.).	nents. H ₃ , SO ₂ , and NO _X . and humidity

ubiect			Spec. No.
Chip Resistor	PRODUCT SPECIFICATION FOR IMF	ORMATION	151-SRJ-EX07A
art No.			44 0
	ERJXGN		11 - 9
1. Laws and Regulatio	ns		
(1) This product has the Montreal Pro	not been manufactured with any ozone-deple	eting chemical	controlled under
(2) This product com	nplies with the RoHS Directive (Restriction of lectrical and electronic equipment (DIRECTIVE		
	d in this part are registered material under th		
	Regulation of Manufacturs, etc. of Chemical		
	used in this part contain no brominated mate		${\sf D}_{\sf S}$ or ${\sf PBB}_{\sf S}$ as the
	notice by letter of "A preliminary judgement o	n the laws o	f Japan foreign
	preign Trade control", be sure to let us know.		apan loroign

